

High Voltage Transistor NPN Silicon

MPSA44

ON Semiconductor Preferred Device

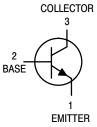
MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector–Emitter Voltage	V _{CEO}	400	Vdc
Collector–Base Voltage	V _{CBO}	500	Vdc
Emitter-Base Voltage	V _{EBO}	6.0	Vdc
Collector Current — Continuous	I _C	300	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	625 5.0	mW mW/°C
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	1.5 12	Watts mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C



THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction to Case	$R_{\theta JC}$	83.3	°C/W



ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit	
OFF CHARACTERISTICS					
Collector–Emitter Breakdown Voltage ⁽¹⁾ (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	400	_	Vdc	
Collector–Emitter Breakdown Voltage $(I_C = 100 \mu Adc, V_{BE} = 0)$		500	_	Vdc	
Collector–Base Breakdown Voltage ($I_C = 100 \mu Adc$, $I_E = 0$)	V _{(BR)CBO}	500	_	Vdc	
Emitter–Base Breakdown Voltage ($I_E = 10 \mu Adc, I_C = 0$)	V _{(BR)EBO}	6.0	_	Vdc	
Collector Cutoff Current (V _{CB} = 400 Vdc, I _E = 0)	I _{CBO}	_	0.1	μAdc	
ollector Cutoff Current (V _{CE} = 400 Vdc, V _{BE} = 0)		_	500	nAdc	
Emitter Cutoff Current $(V_{EB} = 4.0 \text{ Vdc}, I_{C} = 0)$	I _{EBO}	_	0.1	μAdc	

^{1.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

Preferred devices are ON Semiconductor recommended choices for future use and best overall value.

ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit	
ON CHARACTERISTICS ⁽¹⁾					
DC Current $Gain^{(1)}$ ($I_C = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 10 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 50 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$) ($I_C = 100 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}$)	h _{FE}	40 50 45 40	 200 	_	
Collector–Emitter Saturation Voltage ⁽¹⁾ $(I_C = 1.0 \text{ mAdc}, I_B = 0.1 \text{ mAdc})$ $(I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc})$ $(I_C = 50 \text{ mAdc}, I_B = 5.0 \text{ mAdc})$	V _{CE(sat)}	_ _ _	0.4 0.5 0.75	Vdc	
Base–Emitter Saturation Voltage (I _C = 10 mAdc, I _B = 1.0 mAdc)	V _{BE(sat)}	_	0.75	Vdc	
SMALL-SIGNAL CHARACTERISTICS					
Output Capacitance (V _{CB} = 20 Vdc, I _E = 0, f = 1.0 MHz)	C _{obo}	_	7.0	pF	
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)	C _{ibo}	_	130	pF	
Small–Signal Current Gain (I _C = 10 mAdc, V _{CE} = 10 Vdc, f = 20 MHz)	h _{fe}	1.0	_	_	

^{1.} Pulse Test: Pulse Width $\leq 300~\mu s$, Duty Cycle $\leq 2.0\%$.

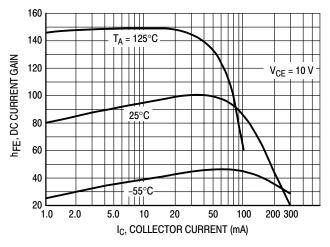


Figure 1. DC Current Gain

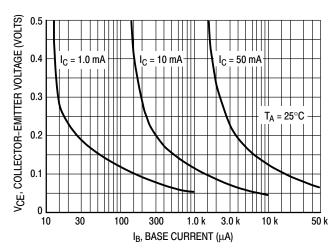


Figure 2. Collector Saturation Region

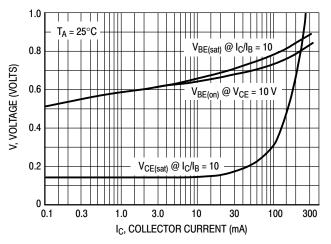


Figure 3. "On" Voltages

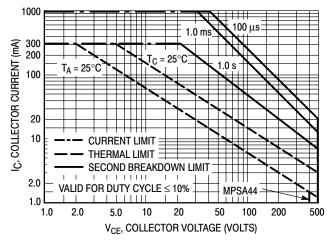


Figure 4. Active Region — Safe Operating Area

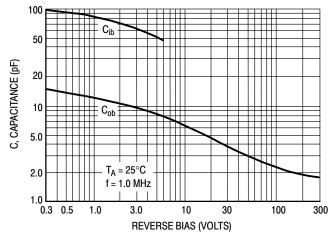


Figure 5. Capacitance

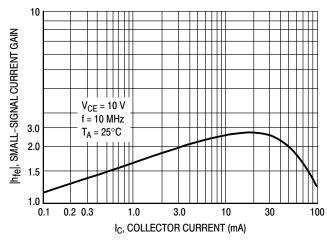


Figure 6. High Frequency Current Gain

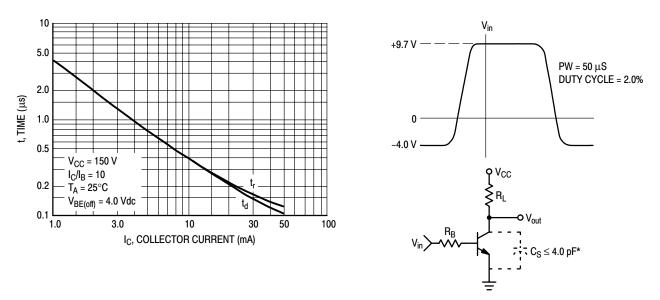


Figure 7. Turn-On Switching Times and Test Circuit

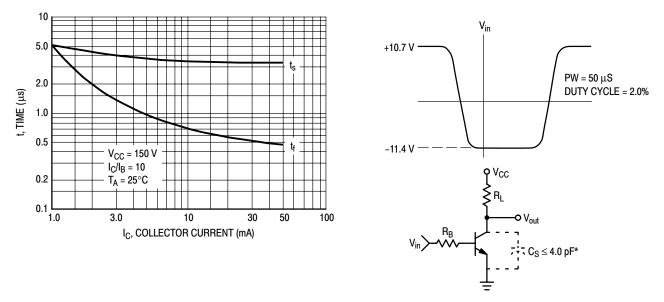
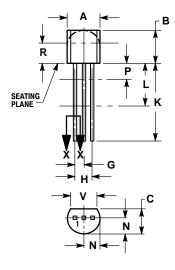


Figure 8. Turn-Off Switching Times and Test Circuit

*Total Shunt Capacitance or Test Jig and Connectors.

PACKAGE DIMENSIONS

TO-92 (TO-226) CASE 29-11 ISSUE AL





STYLE 1: PIN 1. EMITTER

2. BASE 3. COLLECTOR

- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	

Notes

Notes

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